

#### NOT RECOMMENDED FOR NEW DESIGN **USE DMP2120U**



**DMP2215L** 

#### P-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

### **Features**

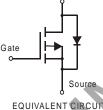
- Low On-Resistance:
  - $R_{DS(ON)} < 100 \text{m}\Omega$  @  $V_{GS} = -4.5 \text{V}$ ,  $I_D = -2.7 \text{A}$
  - $R_{DS(ON)} < 215m\Omega @ V_{GS} = -2.5V, I_D = -2.0A$
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

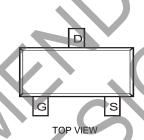
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)







SOT23



TOP VIEW

## Ordering Information (Note 4)

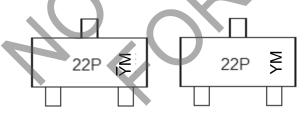
		$\overline{}$		
Part Number		Case		Packaging
DMP2215L-7		 SOT23		3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See <a href="http://www.diodes.com/quality/lead\_free.html">http://www.diodes.com/quality/lead\_free.html</a> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

  4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**



22P = Product Type Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test Site) YM = Date Code Marking for CAT (Chengdu Assembly/ Test Site) Y or  $\overline{Y}$  = Year (ex: E = 2017)

M = Month (ex: 9 = September)

Chengdu A/T Site

Shanghai A/T Site

Date Code Key

Year	2007	2008	2009	2010	201	1 20	12	2013	2014	2015	2016	2017
Code	U	V	W	Х	Y		Z	Α	В	С	D	Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

1 of 5 DMP2215L Document number: DS31125 Rev. 9 - 3



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# **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Cha	racteristic		Symbol	Value	Unit
Drain-Source Voltage			$V_{DSS}$	-20	V
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Drain Current (Note 5)	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	-2.7 -2	А
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	-8	Α

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P <sub>D</sub>	1.08	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	$R_{ heta JA}$	115	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

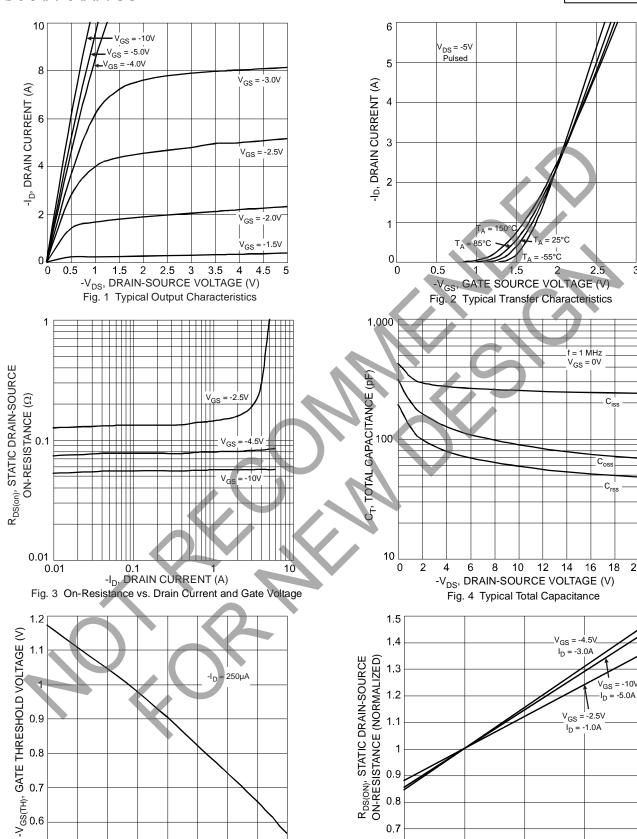
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_		V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	7	_	-800	nA	$V_{DS} = -20V, V_{GS} = 0V$
On-State Drain Current	I <sub>D(ON)</sub>	-6 -3	_		Α	$V_{DS} \le -5V, V_{GS} = -4.5V$ $V_{DS} \le -5V, V_{GS} = -2.5V$
Gate-Source Leakage	Igss		\ <u> </u>	±80	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(TH)}$	-0.45		-1.25	<b>V</b>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		80 165	100 215	mΩ	$V_{GS} = -4.5V, I_D = -2.7A$ $V_{GS} = -2.5V, I_D = -2.0A$
Forward Transfer Admittance	Y <sub>fs</sub>	4.	4		S	V <sub>DS</sub> = -5V, I <sub>D</sub> = -2.7A
Diode Forward Voltage (Note 7)	V <sub>SD</sub>	<b>X</b> -/		-1.26	V	$V_{GS} = 0V, I_{S} = -2.7A$
DYNAMIC CHARACTERISTICS (Note 8)			•			
Input Capacitance	Ciss		250		рF	10)/ )/
Output Capacitance	C <sub>oss</sub>		88		рF	$V_{DS} = -10V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	Crss		58		рF	1 = 1.000112
Gate Resistance	$R_g$		12	16	Ω	$V_{GS} = 0V$ , $V_{DS} = 0V$ , $f = 1MHz$
Total Gate Charge	$Q_g$		4.3	5.3		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Gate-Source Charge	$Q_{gs}$		0.9		nC	$V_{GS} = -4.5V$ , $V_{DS} = -10V$ , $I_{D} = -2.7A$
Gate-Drain Charge	$Q_{gd}$		2.1			

Notes:

- 5. Device mounted on FR-4 PCB. t ≤5 sec.
  6. Pulse width ≤10μS, Duty Cycle ≤1%.
  7. Short duration pulse test used to minimize self-heating effect.
  8. Guaranteed by design. Not subject to product testing.





-25 0 25 50 75 100 1 T<sub>A</sub>, AMBIENT TEMPERATURE (°C) Fig. 5 Gate Threshold Voltage vs. Ambient Temperature

0.5

0.8

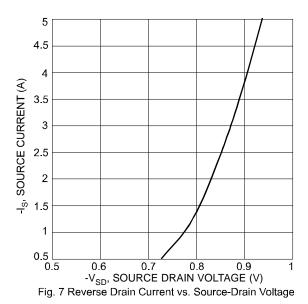
0.7

0.6

-55

150

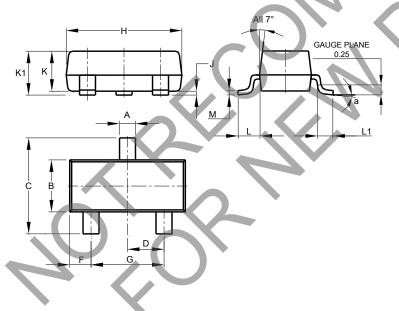




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.





SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°					
All	All Dimensions in mm						



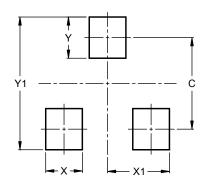
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## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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5 of 5 **DMP2215L** December 2017 Document number: DS31125 Rev. 9 - 3 © Diodes Incorporated 单击下面可查看定价,库存,交付和生命周期等信息

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